Very Low Dropout/Ultra Low Noise 5 Outputs Voltage Regulator

The MC33765 is an ultra low noise, very low dropout voltage regulator with five independent outputs which is available in TSSOP-16 surface mount package.

The MC33765 is available in 2.8 V. The output voltage is the same for all five outputs but each output is capable of supplying different currents up to 150 mA for output 4. The device features a very low dropout voltage (0.11 V typical for maximum output current), very low quiescent current (5.0 μ A maximum in OFF mode, 130 μ A typical in ON mode) and one of the output (output 3) exhibits a very low noise level which allows the driving of noise sensitive circuitry. Internal current and thermal limiting protections are provided.

Additionally, the MC33765 has an independent Enable input pin for each output. It includes also a common Enable pin to shutdown the complete circuit when not used. *The Common Enable pin has the highest priority over the five independent Enable input pins.*

The voltage regulators VR1, VR2 and VR3 have a common input voltage pin V_{CC} 1. The other voltage regulators VR4 and VR5 have a common input voltage pin V_{CC} 2.

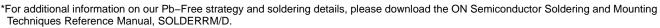
Features

- Five Independent Outputs at 2.8V Typical, Based Upon Voltage Version
- Internal Trimmed Voltage Reference
- V_{out} Tolerance $\pm 3.0\%$ over the Temperature Range -40° C to $+85^{\circ}$ C
- Enable Input Pin (Logic–Controlled Shutdown) for Each of the Five Outputs
- Common Enable Pin to Shutdown the Whole Circuit
- Very Low Dropout Voltage (0.11 V Typical for Output 1, 2, 3 and 5; 0.17 V Typical for Output 4 at Maximum Current)
- Very Low Quiescent Current (Maximum 5.0 μA in OFF Mode, 130 μA Typical in ON Mode)
- Ultra Low Noise for VR3 (30 μV RMS Max, 100 Hz < f < 100 kHz)
- Internal Current and Thermal Limit
- 100 nF for VR1, VR2, VR4 and VR5 and 1.0 μF for VR3 for Stability
- Supply Voltage Rejection: 60 dB (Typical) @ f = 1.0 kHz
- These are Pb–Free Devices*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Power Supply Voltage	V _{CC}	5.3	V
Thermal Resistance Junction-to-Air	R_{\thetaJA}	140	°C/W
Operating Ambient Temperature	T _A	-40 to +85	°C
Maximum Operating Junction Temperature	TJ	125	°C
Maximum Junction Temperature	T _{Jmax}	150	°C
Storage Temperature Range	T _{stg}	-60 to +150	°C

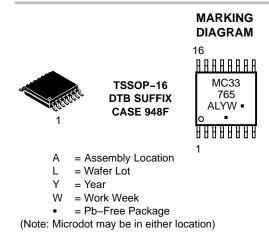
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

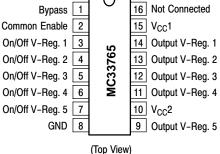




ON Semiconductor®

http://onsemi.com



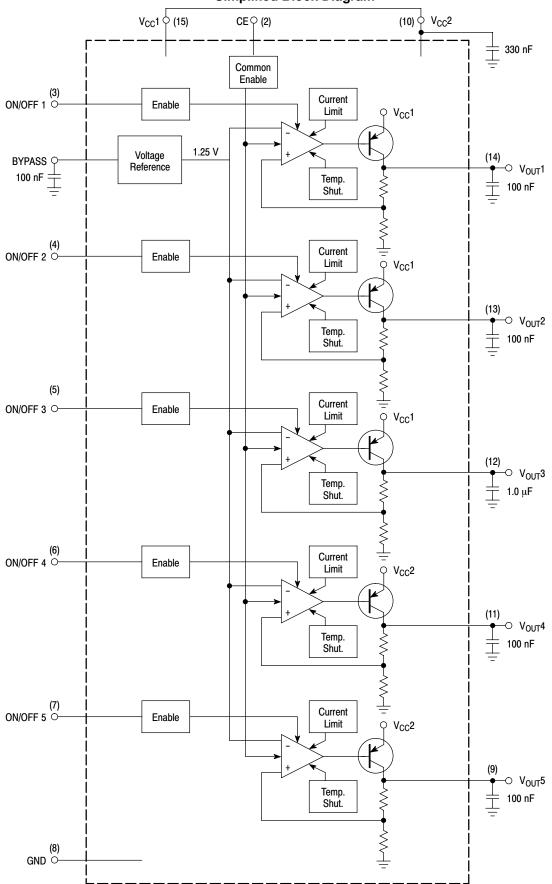


ORDERING INFORMATION

Device	Package*	Shipping [†]						
MC33765DTB	TSSOP-16	96 Units/Rail						
MC33765DTBG	TSSOP-16	96 Units/Rail						
MC33765DTBR2	TSSOP-16	2500 Tape & Reel						
MC33765DTBR2G	TSSOP-16	2500 Tape & Reel						

*This package is inherently Pb-Free.

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



Simplified Block Diagram

CONTROL ELECTRICAL CHARACTERISTICS

ELECTRICAL CHARACTERISTICS (For typical values $T_A = 25^{\circ}C$, for min/max values $T_A = -40^{\circ}C$ to $+85^{\circ}C$ / Max $T_J = 125^{\circ}C$)

Characteristics	Symbol	Pin #	Min	Тур	Max	Unit
INDEPENDENT ENABLE PINS						
Input Voltage Range	V _{ON/OFF(1-5}) –	0	-	V _{CC}	V
Control Input Impedance		-	100	-	-	kΩ
Logic "0", i.e. OFF State Logic "1", i.e. ON State	V _{ON/OFF(1-5}) –	_ 2.0		0.5 _	V
COMMON ENABLE PIN			1		1	1
Input Voltage Range	V _{CE}	2	0	-	V _{CC}	V
Control Input Impedance		2	100	-	-	kΩ
Logic "0", i.e. OFF State Logic "1", i.e. ON State	V _{CE}	2	_ 2.0		0.3 -	V
CURRENT CONSUMPTION WITH NO LOAD			1	1	1	1
Current Consumption at Logic "0" for the complete device, i.e. Common Enable and All Independent Enable pins at OFF State	IQ _O	FF	_	_	5.0	μΑ
Current Consumption at Logic "1" for the complete device, i.e. Common Enable and All Independents Enable pins at ON State	IQ _{ON1}		_	470	_	μΑ
Current Consumption at Logic "1", Common Enable at ON State and All Independents Enable pins at OFF State	IQ _{ON2}		_	130	_	μΑ
SUPPLY AND OUTPUT VOLTAGES, DROPOUT AND LOAD REG	ULATION		<u></u>		1	
Supply Voltage V _{CC} MC33765 (2.8V)	V _{CC1} , V _{CC2}	15, 10	3.0	3.6	5.3	V
Regulator Output Voltage for VR1, VR2, VR3, VR4 and VR5 MC33765 (2.8V)	V _{OUT(1-5)}	14, 13, 12, 11, 9	2.7	2.8	2.85	V
Dropout Voltage for VR1, VR2, VR3, VR5 (Note 1)	V _{CC} -V _{OUT}	14, 13, 12, 9	_	0.11	0.17	V
Dropout Voltage for VR4 (Note 1)	V _{CC} -V _{OUT4}	11	_	0.17	0.30	V
Load Regulation ($T_A = 25^{\circ}C$)	Reg _{load(1-5)}	9, 11, 12, 13, 14	-	-	0.5	mV/m
MAX POWER DISSIPATION AND TOTAL DC OUTPUT CURRENT	(VR1 + VR2 +	VR3 + VR4 +	VR5) (No	te 2)	1	1
Max Power Dissipation at V_{CC} = 5.3 V (T _A = 85°C) Max. Total RMS Output Current at V_{CC} = 5.3 V (T _A = 85°C)	P _{dmax} I _{RMS}	-			285 130	mW mA

IRMS Max Power Dissipation at V_{CC} = 5.3 V (T_A = 25°C) Max. Total RMS Output Current at V_{CC} = 5.3 V (T_A = 25°C) Pdmax 700 mW _ 250 I_{RMS} _ mΑ

Typical dropout voltages have been measured at currents: Output1: 25 mA, Output2: 35 mA, Output3: 40 mA, Output4: 140 mA, Output5: 40 mA Maximum value of dropout voltages are measured at maximum specified current.
See package power dissipation and thermal protection.

REGULATOR ELECTRICAL CHARACTERISTICS

ELECTRICAL CHARACTERISTICS (For typical values $T_A = 25^{\circ}C$, for min/max values $T_A = -40^{\circ}C$ to $+85^{\circ}C$ / Max $T_J = 125^{\circ}C$)

Characteristics	Pin #	Symbol	Min	Тур	Max	Unit
OUTPUT CURRENTS (Note 3)						
Regulator VR1 Output Current	14	I _{OUT1}	10	-	30	mA
Regulator VR2 Output Current	13	I _{OUT2}	10	-	40	mA
Regulator VR3 Output Current	12	I _{OUT3}	0	-	50	mA
Regulator VR4 Output Current	11	I _{OUT4}	10	-	150	mA
Regulator VR5 Output Current	9	I _{OUT5}	10	-	60	mA
Current Limit for VR1, VR2, VR3, VR4, VR5 [Twice the max Output Current for each output]	14, 13, 12, 11, 9	I _{MAX}	-	2 X I _{OUT} (1–5)	-	mA
EXTERNAL CAPACITORS		1	1			1
External Compensation Capacitors for VR1, VR2, VR4, VR5	14, 13, 11, 9	C _(1-2, 4-5)	0.10	-	1.0	μF
External Compensation Capacitors for VR3	12	C ₄	1.0	_	_	μF
External Compensation Capacitors ESR	_	_	0.05	1.0	3.0	Ω
RIPPLE REJECTIONS						1
Ripple Rejection VR1, VR2, VR4, VR5 (at Max. Current, 1.0 kHz, C = 100 nF)	14, 13, 11, 9	$\frac{\rm (\Delta V_{OUT})}{\rm (\Delta V_{CC})}$	50	60	-	dB
Ripple Rejection VR1, VR2, VR4, VR5 (at Max. Current, f = 10 kHz, C = 100 nF)	14, 13, 11, 9	$\frac{\rm (\Delta V_{OUT})}{\rm (\Delta V_{CC})}$	40	45	-	dB
Ripple Rejection of VR3 (at Max. Current, f = 1.0 kHz, C = 1.0 μ F)	12	$\frac{(\Delta V_{OUT})}{(\Delta V_{CC})}$	50	60	-	dB
Ripple Rejection of VR3 (at Max. Current, f = 10 kHz, C = 1.0 μF)	12	$\frac{\rm (\Delta V_{OUT})}{\rm (\Delta V_{CC})}$	40	45	-	dB
Ripple Rejection of VR3 (at Max. Current, f = 100 kHz, C = 1.0 μF)	12	$\frac{(\Delta V_{OUT})}{(\Delta V_{CC})}$	18	22	-	dB
DYNAMIC PARAMETERS	+		ļ			1
Rise Time (1% \rightarrow 99%) Common Enable at ON state, C _{bypass} = 10 nF, I _{out}	at max. current					
VR1, VR2, VR4, VR5 with C _{OUT} = 100 nF, T _A = 25°C VR3 with C _{OUT} = 1.0 μ F, T _A = 25°C		t _{on}	_ _		30 150	μs μs
Fall Time (99% \rightarrow 1%) [C _{OUT} = 100 nF, I _{OUT} = 30 mA] (Note 4)			-	100	-	μs
Overshoot (C_{OUT} = 100 nF for VR1, VR2, VR4, VR5 and C_{OUT} = 1.0 μ F for VR3) at T _A = 25°C Common Enable at ON state, independent enable from OFF to ON state			-	5	8	%
Settling Time (to $\pm 0.1\%$ of nominal) at T _A = 25°C Common Enable at ON state, independent enable from OFF to ON state			_	95	_	μs
NOISE AND CROSSTALKS						
Noise Voltage (100 Hz < f < 100 kHz) with C _{bypass} = 100 nF VR1, VR2, VR4, VR5 with C _{OUT} = 100 nF; VR3 with C _{OUT} = 1.0 μ F		_	_	40 25	_ 30	μV RM
Static crosstalk (DC shift) between the Regulator Output, $T_A = 25^{\circ}C$ (Note 5)		-	-	150	200	μV
Dynamic CrossTalk Attenuation between the Regulator Outputs (f = 10 kHz), $T_A = 25^{\circ}C$ (Note 6)			30	35	-	dB
THERMAL SHUTDOWN		1	1			1
Thermal Shutdown		_	_	160	-	°C

3. Maximum Output Currents are peak values. Total DC current have to be set upon maximum power dissipation specification. Only Output

 Maximum output output output values. This possibility output is a been designed to be stable at minimum current of 0 mA.
The Fall time is highly dependent on the load conditions, i.e. load current for a specified value of C_{OUT}.
Static Crosstalk is a DC shift caused by switching ON one of the outputs through independent enable to all other outputs. This parameter is highly dependent on overall PCB layout and requires the implementation of low-noise GROUND rules (e.g. Ground plane).
Dynamic crosstalk is the ratio between a forced output signal to signal transferred to other outputs. This requires special device configuration to be more upded. to be measured.

MC33765 TYPICAL OSCILLOSCOPE SHOTS

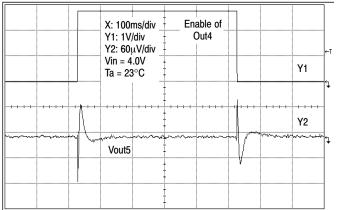


Figure 1. Crosstalk response of MC33765 showing extremely weak interaction between outputs Output 4 is banged from 0 to 150mA

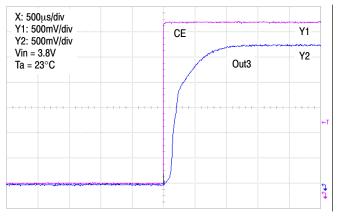


Figure 3. Single Common Enable response time (Cbypass discharged)

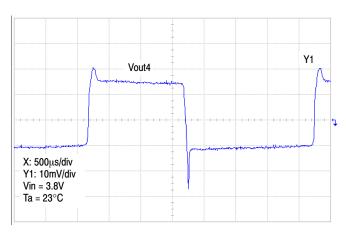


Figure 5. Output 4 is banged from 3mA to 150mA

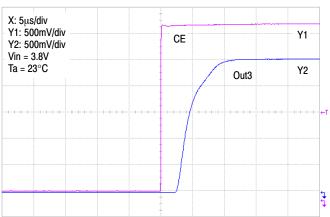


Figure 2. Repetitive Common Enable response time

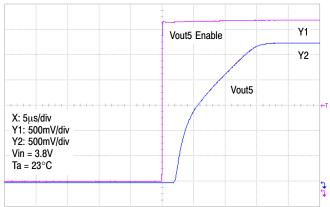
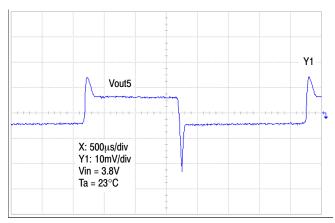
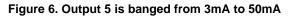
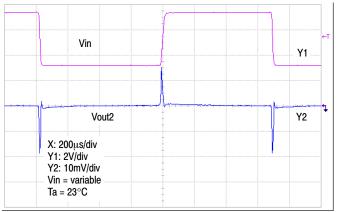


Figure 4. Output response from seperate Enable







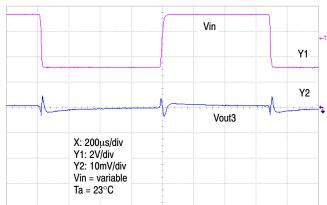


Figure 7. Typical input voltage rejection (Cout = 100nF)

Figure 8. Typical input voltage rejection (Cout = 1μ F)

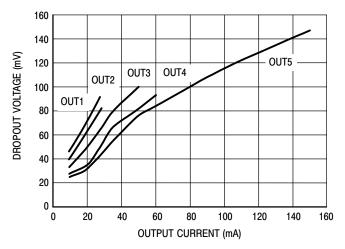
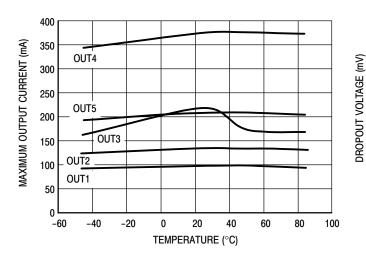


Figure 9. Dropout Voltage versus Output Current





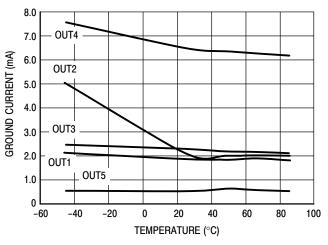
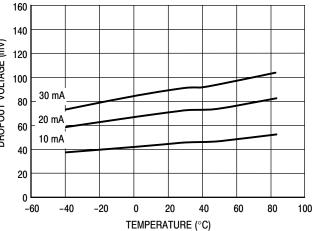


Figure 10. Ground Current versus Individual Output





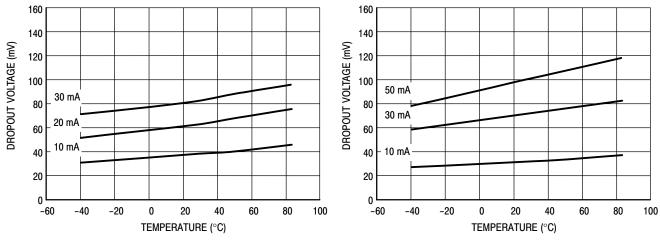


Figure 13. Dropout Voltage versus Operating Temperature: OUT2



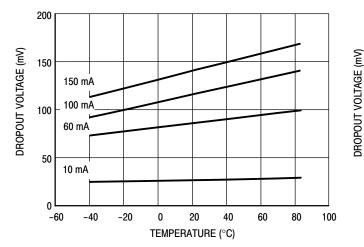


Figure 15. Dropout Voltage versus Operating Temperature: OUT4

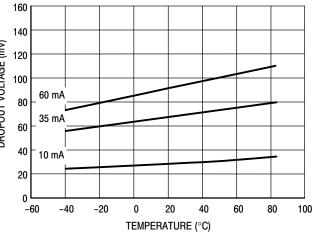


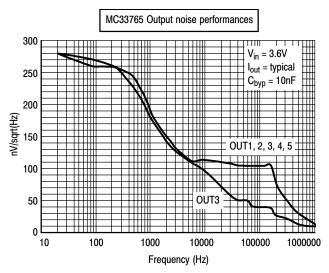
Figure 16. Dropout Voltage versus Operating Temperature: OUT5

DEFINITIONS

Load Regulation – The change in output voltage for a change in load current at constant chip temperature.

Dropout Voltage - The input/output differential at which the regulator output no longer maintains regulation against further reductions in input voltage. Measured when the output drops 100 mV below its nominal value (which is measured at 1.0 V differential input/output), dropout voltage is affected by junction temperature, load current and minimum input supply requirements.

Output Noise Voltage - The RMS AC voltage at the output with a constant load and no input ripple, measured over a specified frequency range.



Maximum Power Dissipation - The maximum total dissipation for which the regulator will operate within specifications.

Quiescent Current - Current which is used to operate the regulator chip with no load current.

Line Regulation - The change in input voltage for a change in the input voltage. The measurement is made under conditions of low dissipation or by using pulse techniques such that the average chip temperature is not significantly affected.

Thermal Protection – Internal thermal shutdown circuitry is provided to protect the integrated circuit in the event that the maximum junction temperature is exceeded. When activated, typically 160°C, the regulator turns off. This feature is provided to prevent catastrophic failures from accidental overheating.

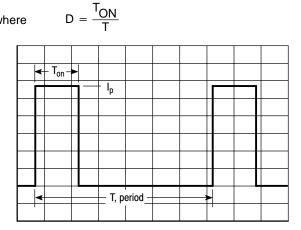
Maximum Package Power Dissipation and RMS Current - The maximum package power dissipation is the power dissipation level at which the junction temperature reaches its maximum value i.e. 125°C. The junction temperature is rising while the difference between the input power ($V_{CC} \times I_{CC}$) and the output power ($V_{out} \times I_{out}$) is increasing.

As MC33765 device exhibits five independent outputs Iout is specified as the maximum RMS current combination of the five output currents.

As the device can be switched ON/OFF through independent Enable (ON/OFF pin) or Common Enable, the output signal could be, for example, a square wave. Let's assume that the device is ON during T_{ON} on a signal period T. The RMS current will be given by:

$$I_{out_{RMS}} = I_{P} \times \sqrt{D}$$

where



Depending on ambient temperature, it is possible to calculate the maximum power dissipation and so the maximum RMS current as following:

$$\mathsf{Pd} = \frac{\mathsf{T}_{\mathsf{J}} - \mathsf{T}_{\mathsf{A}}}{\mathsf{R}_{\mathsf{\theta}\mathsf{J}\mathsf{A}}}$$

The maximum operating junction temperature T_{J} is specified at 125°C, if $T_A = 25$ °C, then $P_D = 700$ mW. By neglecting the quiescent current, the maximum power dissipation can be expressed as:

$$I_{out} = \frac{P_D}{V_{CC} - V_{out}}$$

So that in the more drastic conditions:

 $V_{CC} = 5.3 \text{ V}, V_{out} = 2.7 \text{ V}$ then the maximum RMS value of I_{out} is 269 mA.

The maximum power dissipation supported by the device is a lot increased when using appropriate application design. Mounting pad configuration on the PCB, the board material and also the ambient temperature are affected the rate of temperature rise. It means that when the I_C has good thermal conductivity through PCB, the junction temperature will be "low" even if the power dissipation is great.

The thermal resistance of the whole circuit can be evaluated by deliberately activating the thermal shutdown of the circuit (by increasing the output current or raising the input voltage for example).

Then you can calculate the power dissipation by subtracting the output power from the input power. All variables are then well known: power dissipation, thermal shutdown temperature (160°C for MC33765) and ambient temperature.

$$R_{\theta JA} = \frac{T_J - T_A}{P_D}$$

DESIGN HINTS Reducing the cross-talk between the MC33765 outputs

One of the origin of the DC shift finds its seat in the layout surrounding the integrated circuit. Particular care has to be taken when routing the output ground paths. Star grounding or a ground plane are the absolute conditions to reduce the noise or shift associated to common impedance situations, as depicted by Figure 17.

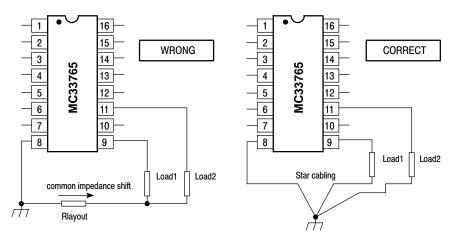


Figure 17. Star Cabling Avoids Coupling by Common Ground Impedance

The first left cabling will generate a voltage shift which will superimpose on the output voltages, thus creating an undesirable offset. By routing the return grounds to a single low impedance point, you naturally shield the circuit against common impedance disturbances. Figure 18 portraits the text fixture implemented to test the response of the MC33765.

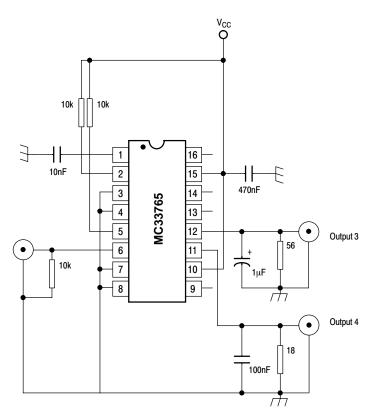


Figure 18. DC Shift Text Fixture

DESIGN HINTS (cont.)

Output 4 was banged from 0 to 150mA via its dedicated control pin, while output 3 fixed at 50mA was monitored. The circuit has been implemented on a PCB equipped with a

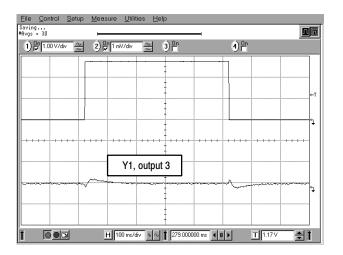


Figure 19. Vin = 4V, Y1 = 62.5μ V/div, F = 200Hz

ground plane and routed with short copper traces. The results are shown hereafter, revealing the excellent behavior of the MC33765 when crosstalks outputs is at utmost importance.

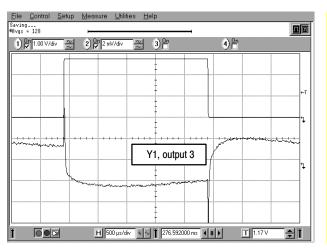


Figure 20. Vin = 5V, Y1 = 1mV/div

TECHNICAL TERMS

Rise Time – Common Enable being in ON state, the device is switched on by ON/OFF pin control.

Let's call t_1 the time when ON/OFF signal reaches 1% of its nominal value.

Let's call t_2 the time when output signal reaches 99% of its nominal value.

The rise time for this device is specified as:

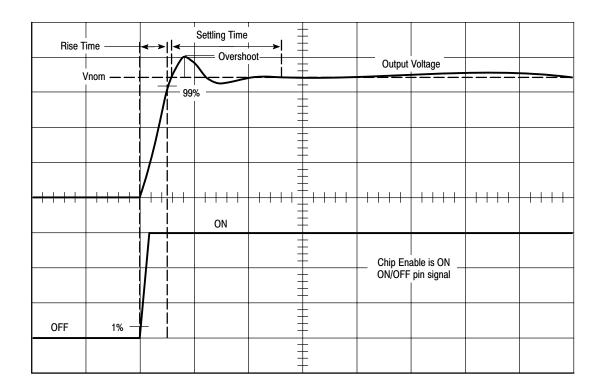
$$t_{ON} = t_1 - t_2$$

Fall Time – The fall time is highly dependent on the output capacitor and so device design is not impacting at all this parameter.

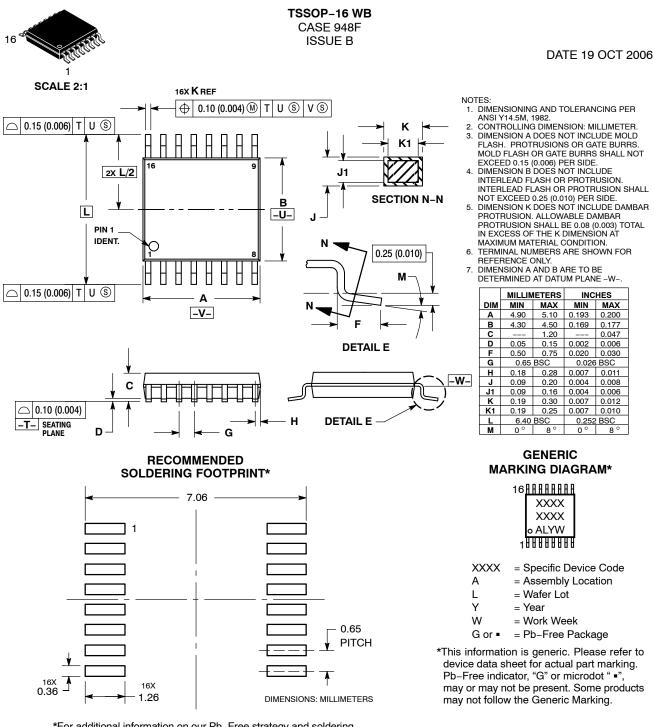
Overshoot, Settling Time – As regulators are based on regulation loop through an error amplifier, this type of device requires a certain time to stabilize and reach its nominal value.

The overshoot is defined as the voltage difference between the peak voltage and steady state when switching ON the regulator.

The settling time is equal to the time required by the regulator to stabilize to its nominal value ($\pm 0.5\%$) after peak value when switching ON the regulator.



onsemi



*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DOCUMENT NUMBER:	98ASH70247A	Electronic versions are uncontrolled except when accessed directly from the Document Repository Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.				
DESCRIPTION:	TSSOP-16		PAGE 1 OF 1			
onsemi and OOSEMi are trademarks of Semiconductor Components Industries. LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves						

onsemit and OTISCT III are trademarks of Semiconductor Components industrials, LLC dua onsemit or its subsidiaries in the Onited States and/or other countries. Onsemit reserves the right to make changes without further notice to any products herein. **onsemi** makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. **onsemi** does not convey any license under its patent rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>